



BULK118

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- BULK118 IS REVERSE PINS OUT Vs STANDARD SOT-82 PACKAGE AND SAME PINS OUT Vs BULT118 (SOT-32 PACKAGE)
- STMicroelectronics PREFERRED SALESTYPES
- NPN TRANSISTOR
- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

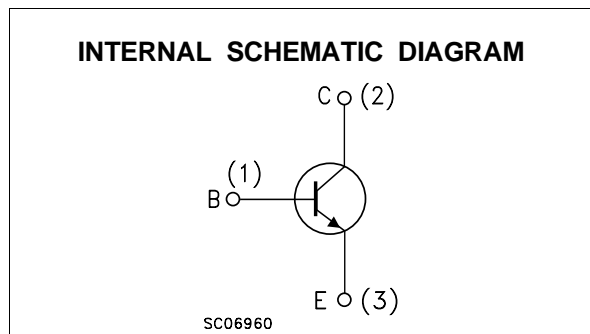
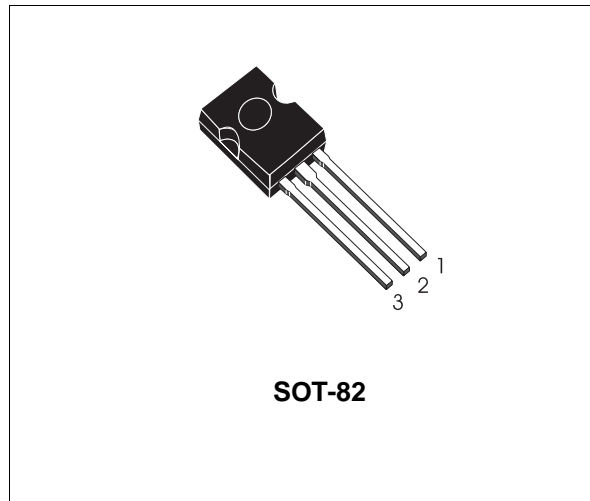
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS

DESCRIPTION

The devices are manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

They use a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The devices are designed for use in lighting applications and low cost switch-mode power supplies.



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|-----------|--|------------|------|
| V_{CES} | Collector-Emitter Voltage ($V_{BE} = 0$) | 700 | V |
| V_{CEO} | Collector-Emitter Voltage ($I_B = 0$) | 400 | V |
| V_{EBO} | Emitter-Base Voltage ($I_C = 0$) | 9 | V |
| I_C | Collector Current | 2 | A |
| I_{CM} | Collector Peak Current ($t_p < 5$ ms) | 4 | A |
| I_B | Base Current | 1 | A |
| I_{BM} | Base Peak Current ($t_p < 5$ ms) | 2 | A |
| P_{tot} | Total Dissipation at $T_C = 25$ °C | 45 | W |
| T_{stg} | Storage Temperature | -65 to 150 | °C |
| T_j | Max. Operating Junction Temperature | 150 | °C |

THERMAL DATA

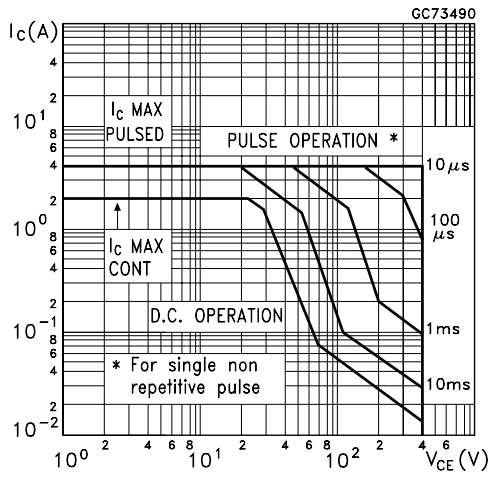
| | | | | |
|-----------------------|-------------------------------------|-----|------|------|
| R _{thj-case} | Thermal Resistance Junction-Case | Max | 2.77 | °C/W |
| R _{thj-amb} | Thermal Resistance Junction-Ambient | Max | 80 | °C/W |

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

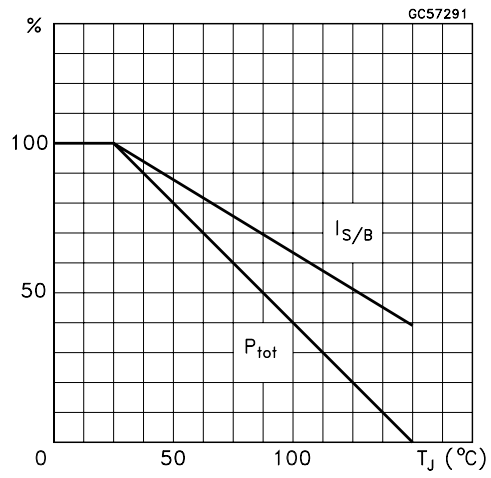
| Symbol | Parameter | Test Conditions | | Min. | Typ. | Max. | Unit |
|--|---|--|--|---------------|--------------------|-------------------|----------------|
| I _{CES} | Collector Cut-off Current (V _{BE} = 0) | V _{CE} = 700 V V _{CE} = 700 V | T _j = 125 °C | | | 100 500 | μA μA |
| V _{EBO} | Emitter-Base Voltage | I _E = 10 mA | | 9 | | | V |
| V _{CEO(sus)} * | Collector-Emitter Sustaining Voltage (I _B = 0) | I _C = 100 mA | L = 25 mH | 400 | | | V |
| I _{CEO} | Collector-Emitter Leakage Current | V _{CE} = 400 V | | | | 250 | μA |
| V _{CE(sat)} * | Collector-Emitter Saturation Voltage | I _C = 0.5 A I _C = 1 A I _C = 2 A | I _B = 0.1 A I _B = 0.2 A I _B = 0.4 A | | | 0.5 1 1.5 | V V V |
| V _{BE(sat)} * | Base-Emitter Saturation Voltage | I _C = 0.5 A I _C = 1 A I _C = 2 A | I _B = 0.1 A I _B = 0.2 A I _B = 0.4 A | | | 1.0 1.2 1.3 | V V V |
| h _{FE} * | DC Current Gain | I _C = 10 mA I _C = 0.5 A I _C = 2 A | V _{CE} = 5 V V _{CE} = 5 V V _{CE} = 5 V | 10 10 8 | | 50 | |
| t _r t _s t _f | RESISTIVE LOAD Rise Time Storage Time Fall Time | V _{CC} = 125 V I _{B1} = 0.2 A | I _C = 1 A I _{B2} = -0.2 A | | 0.4 3.2 0.25 | 0.7 4.5 0.4 | μs μs μs |
| t _s t _f | INDUCTIVE LOAD Storage Time Fall Time | I _C = 1 A V _{BE} = -5 V V _{clamp} = 300 V | I _{B1} = 0.2 A L = 50 mH | | 0.8 0.16 | | μs μs |

* Pulsed: Pulse duration = 300 ms, duty cycle 1.5 %

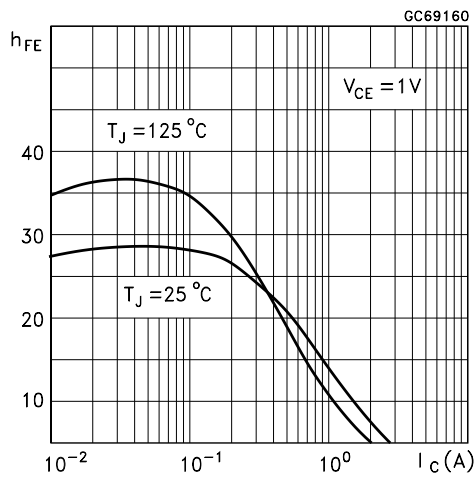
Safe Operating Areas



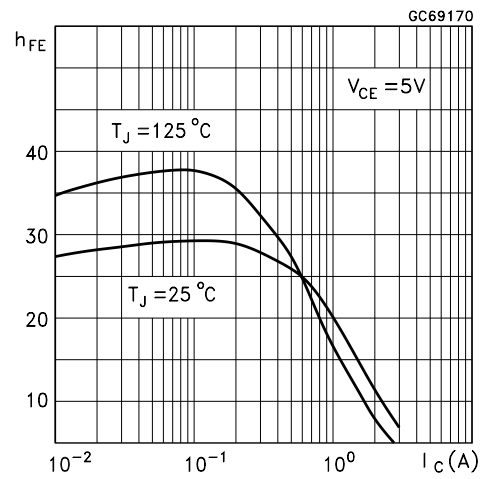
Derating Curve



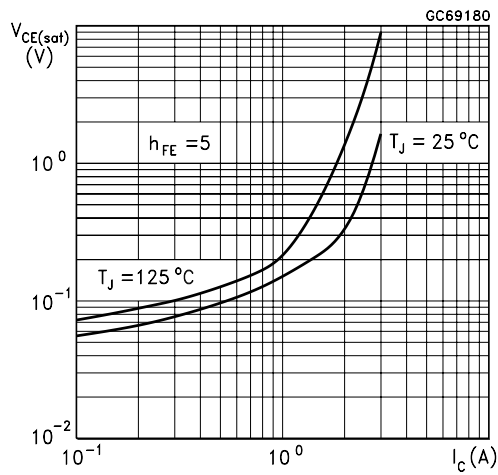
DC Current Gain



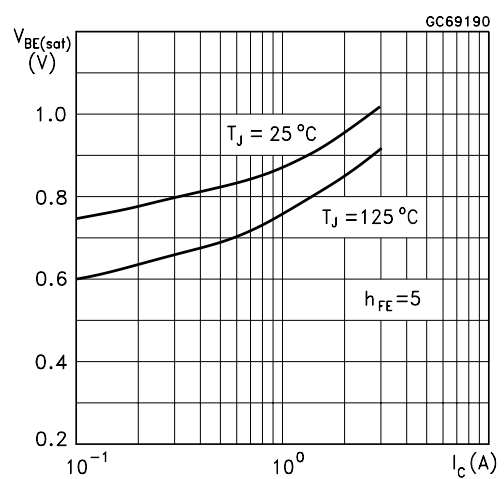
DC Current Gain



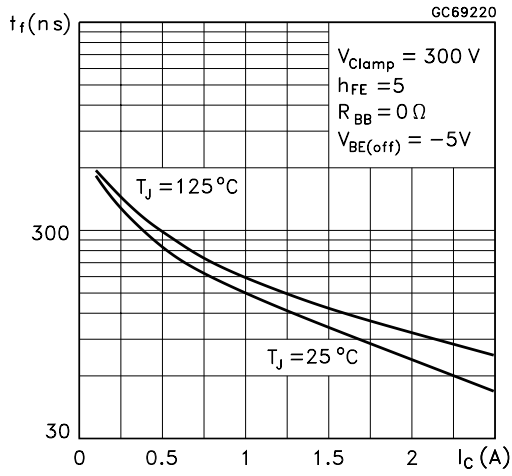
Collector Emitter Saturation Voltage



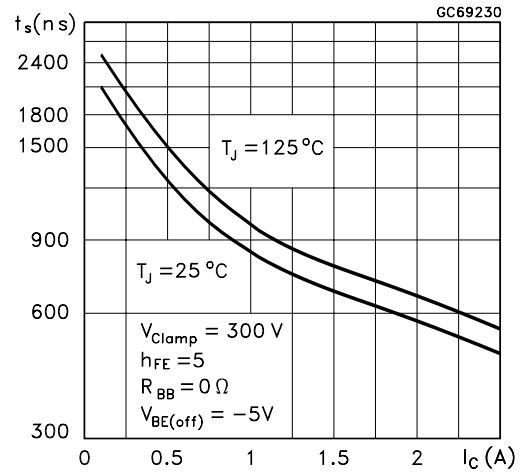
Base Emitter Saturation Voltage



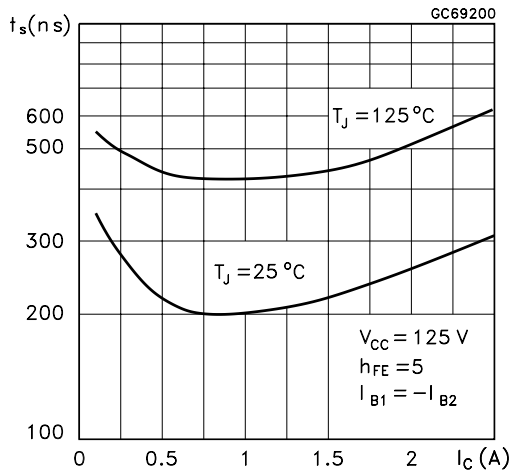
Inductive Load Fall Time



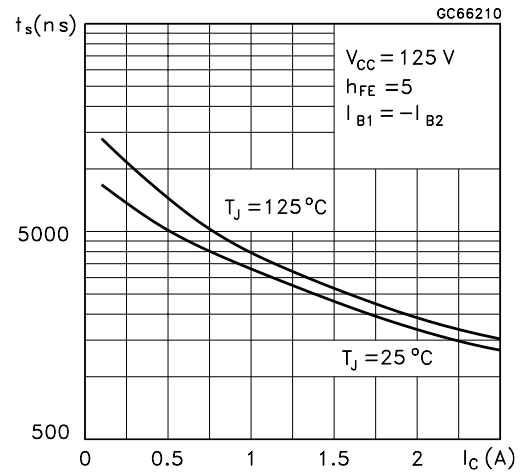
Inductive Load Storage Time



Resistive Load Fall Time



Resistive Load Storage Time



Reverse Biased SOA

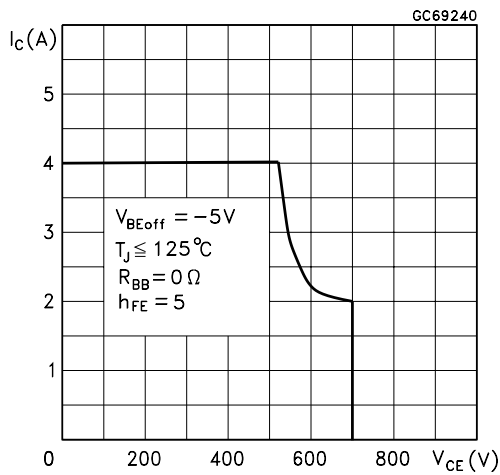


Figure 1: Inductive Load Switching Test Circuits.

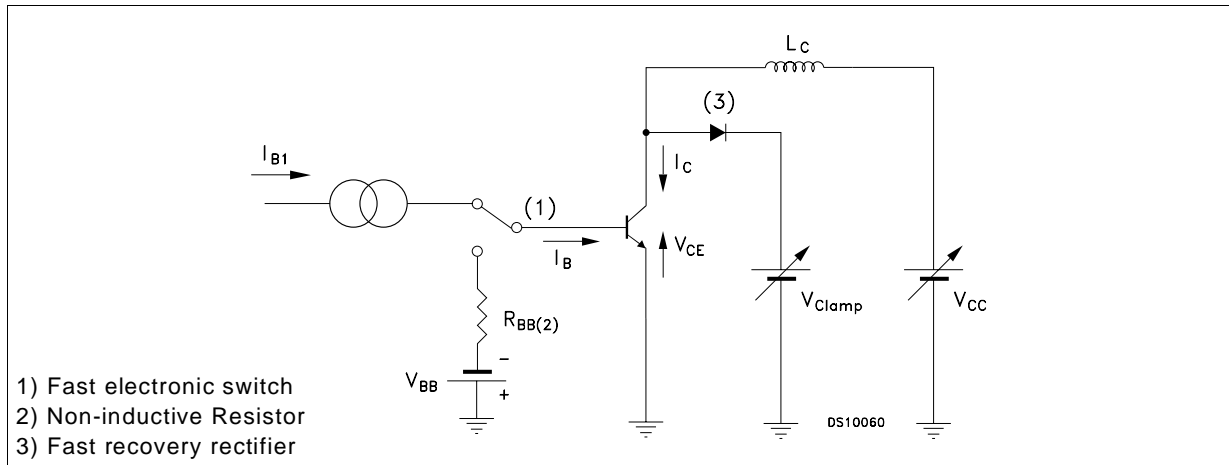
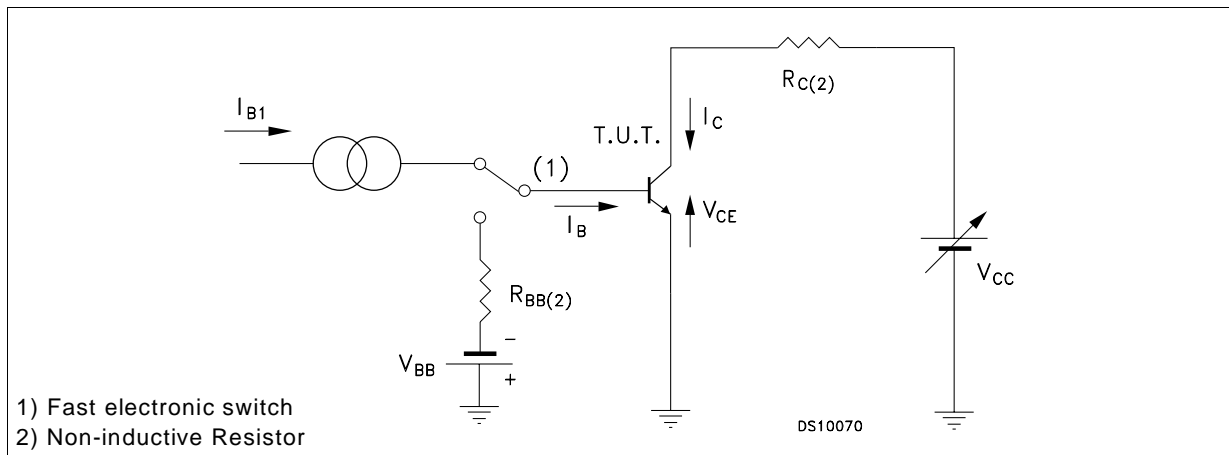
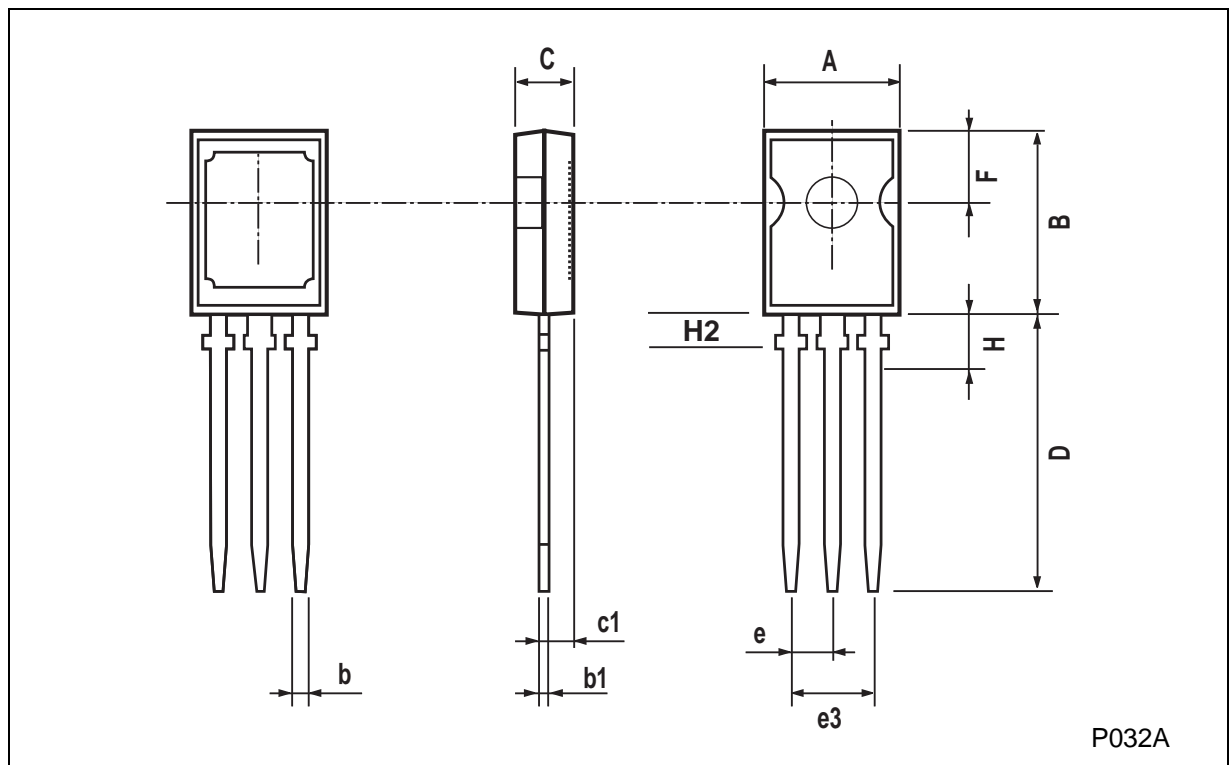


Figure 2: Resistive Load Switching Test Circuits.



SOT-82 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------|------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 7.4 | | 7.8 | 0.291 | | 0.307 |
| B | 10.5 | | 10.8 | 0.413 | | 0.444 |
| b | 0.7 | | 0.9 | 0.028 | | 0.035 |
| b1 | 0.49 | | 0.75 | 0.019 | | 0.030 |
| C | 2.4 | | 2.7 | 0.04 | | 0.106 |
| c1 | 1.0 | | 1.3 | 0.039 | | 0.05 |
| D | 15.4 | | 16 | 0.606 | | 0.629 |
| e | | 2.2 | | | 0.087 | |
| e3 | 4.15 | | 4.65 | 0.163 | | 0.183 |
| F | | 3.8 | | | 0.150 | |
| H | | | 2.54 | | 0.100 | |
| H2 | | 2.15 | | | 0.084 | |



P032A

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